

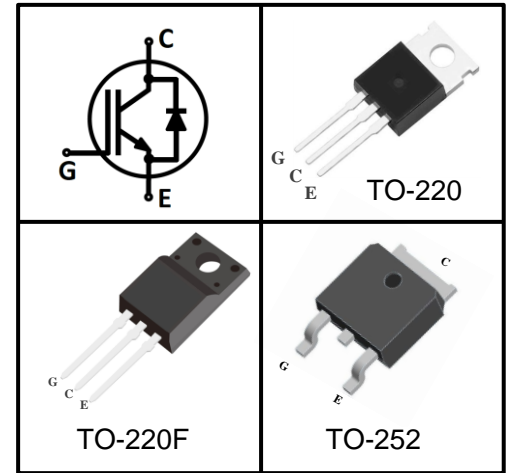
## Features

- Easy parallel switching capability due to positive temperature coefficient in  $V_{CEsat}$
- Low  $V_{CEsat}$ , fast switching
- High ruggedness, good thermal stability
- Very tight parameter distribution

Type	Marking	Package Code
MPBP10N65EF	MP10N65EF	TO-220-3
MPBA10N65EF	MP10N65EF	TO-220F-3
MPBD10N65EF	MP10N65EF	TO-252

## Applications

- Motor Drives



## Maximum Rated Values <sup>1</sup>

Parameter	Symbol	Value			Unit
		220	220F	252	
Collector-emitter voltage	$V_{CE}$	650			V
DC collector current <sup>2</sup>					A
$T_C=25^\circ\text{C}$	$I_C$	15			
$T_C=100^\circ\text{C}$		10			
Pulsed collector current <sup>3</sup>	$I_{Cpuls}$	20			
Diode forward current <sup>2</sup>					
$T_C=25^\circ\text{C}$	$I_F$	20			
$T_C=100^\circ\text{C}$		10			
Diode pulsed current <sup>3</sup>	$I_{Fpuls}$	24			
Short circuit withstanding time $V_{GE} = 15\text{V}, V_{CC} \leq 400\text{V}$	$t_{SC}$	5			us
Gate-emitter voltage	$V_{GE}$	$\pm 20$			V
Transient Gate-emitter voltage ( $t_p \leq 10\mu\text{s}$ )		$\pm 30$			
Power dissipation					W
$T_C=25^\circ\text{C}$	$P_{tot}$	115	32	68	
$T_C=100^\circ\text{C}$		58	16	34	
Operating junction temperature	$T_j$	-55~175			°C
Storage temperature	$T_{stg}$	-55~150			

1:Reference standard: JESD-022 2: limited by  $T_{jmax}$  3:  $T_p$  limited by  $T_{jmax}$  ;



### Thermal Characteristics

Parameter	Symbol	Max			Unit
		220	220F	252	
IGBT thermal resistance, junction-case	$R_{thJC}$	1.3	4.6	2.2	K/W
Diode thermal resistance, junction-case	$R_{thJCD}$	2.4	5.6	2.9	
Thermal Resistance, junction-ambient	$R_{thJA}$	62.5	65	62.5	

### Electrical Characteristics (at $T_j=25^\circ\text{C}$ , unless otherwise specified) Static Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_C=0.25mA$	650	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=10A, T_j=25^\circ\text{C}$	-	1.40	1.80	
		$T_j=125^\circ\text{C}$	-	1.65	-	
		$T_j=150^\circ\text{C}$	-	1.75	-	
Diode forward voltage	$V_F$	$V_{GE}=0V, I_F=10A, T_j=25^\circ\text{C}$	-	1.65	1.95	
		$T_j=125^\circ\text{C}$	-	1.30	-	
		$T_j=150^\circ\text{C}$	-	1.20	-	
G-E threshold voltage	$V_{GE(th)}$	$I_C=150\mu A, V_{CE}=V_{GE}$	4.5	5.8	6.5	
C-E leakage current	$I_{CES}$	$V_{CE}=650V, V_{GE}=0V, T_j=25^\circ\text{C}$	-	-	0.01	mA
		$T_j=150^\circ\text{C}$	-	-	1.0	
G-E leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	-	-	250	nA
Transconductance	$g_{FS}$	$V_{CE}=20V, I_C=10A$	-	5	-	S

### Dynamic Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input capacitance	$C_{iss}$	$V_{CE}=25V, V_{GE}=0V, f=1MHz$	-	1000	-	pF
Output capacitance	$C_{oss}$		-	45	-	
Reverse transfer capacitance	$C_{riss}$		-	16	-	
Gate charge	$Q_G$	$V_{CC}=300V, I_C=10A, V_{GE}=15V$	-	58	-	nC

## IGBT Switching Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Turn-on delay time	$t_{d(on)}$	$T_j=25^{\circ}\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=10\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	47	-	ns
Rise time	$t_r$		-	28	-	
Turn-off delay time	$t_{d(off)}$		-	103	-	
Fall time	$t_f$		-	80	-	
Turn-on energy	$E_{on}$		-	0.17	-	mJ
Turn-off energy	$E_{off}$		-	0.20	-	
Total switching energy	$E_{ts}$		-	0.37	-	
Turn-on delay time	$t_{d(on)}$	$T_j=150^{\circ}\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=10\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=10\Omega$ , Inductive load	-	63.2	-	ns
Rise time	$t_r$		-	30.4	-	
Turn-off delay time	$t_{d(off)}$		-	149.2	-	
Fall time	$t_f$		-	111	-	
Turn-on energy	$E_{on}$		-	0.287	-	mJ
Turn-off energy	$E_{off}$		-	0.280	-	
Total switching energy	$E_{ts}$		-	0.567	-	

## Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Diode reverse recovery time	$t_{rr}$	$T_j=25^{\circ}\text{C}$ , $V_R=400\text{V}$ , $I_F=10\text{A}$ , $di_F/dt=350\text{A}/\mu\text{s}$	-	66	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.23	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	5.55	-	A
Diode reverse recovery time	$t_{rr}$	$T_j=150^{\circ}\text{C}$ , $V_R=400\text{V}$ , $I_F=10\text{A}$ , $di_F/dt=357\text{A}/\mu\text{s}$	-	95	-	ns
Diode reverse recovery charge	$Q_{rr}$		-	0.59	-	$\mu\text{C}$
Diode peak reverse recovery current	$I_{rrm}$		-	10.20	-	A

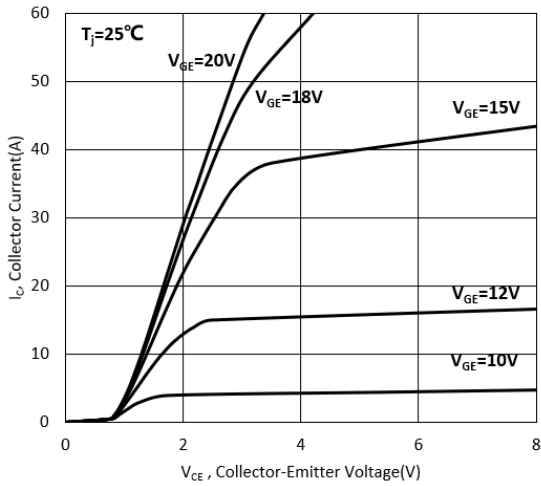


Figure 1. Typical output characteristic ( $T_j = 25^\circ\text{C}$ )

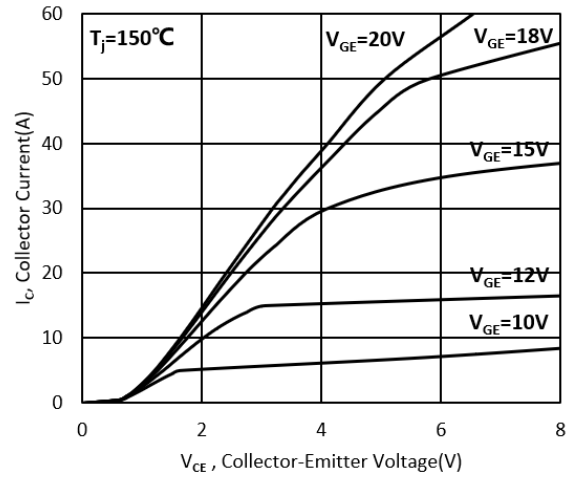


Figure 2. Typical output characteristic ( $T_j = 150^\circ\text{C}$ )

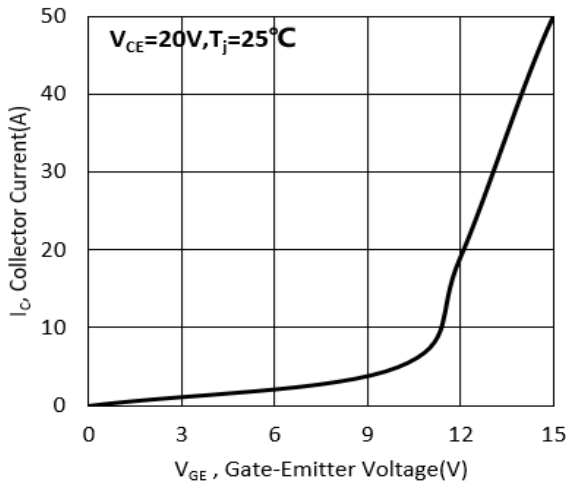


Figure 3. Typical transfer characteristic ( $T_j = 25^\circ\text{C}$ )

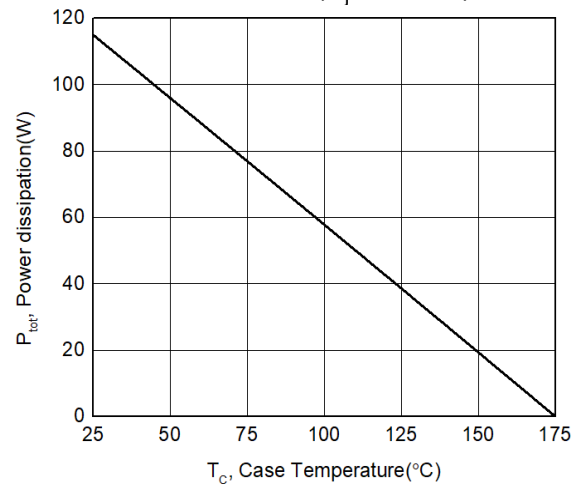


Figure 4. Power dissipation as a function of case temperature (TO-220)

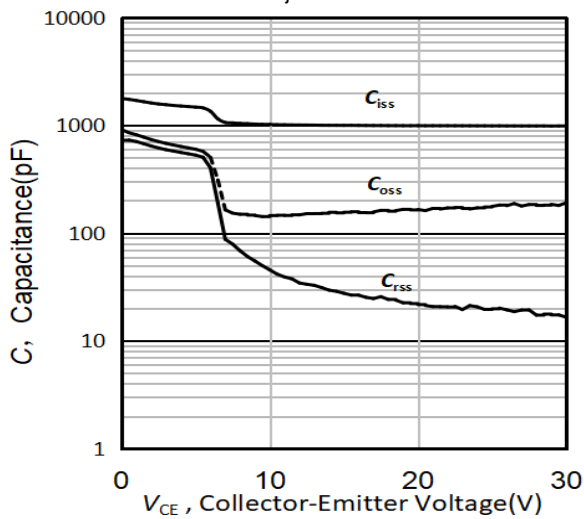


Figure 5. Capacitance characteristic ( $V_{GE} = 0\text{V}$ ,  $f = 1\text{MHz}$ )

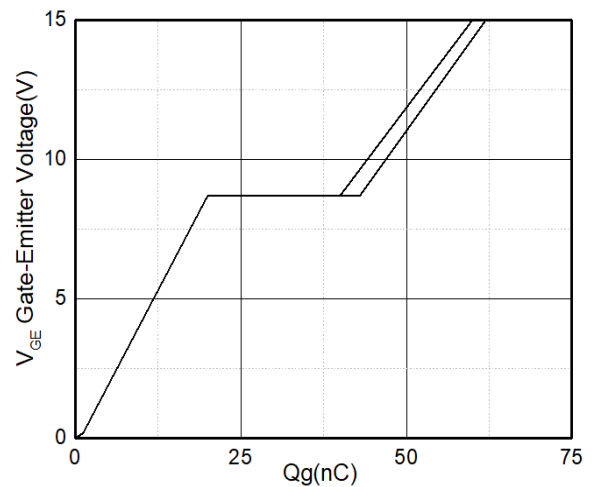


Figure 6. Typical gate charge ( $I_C = 10\text{A}$ )

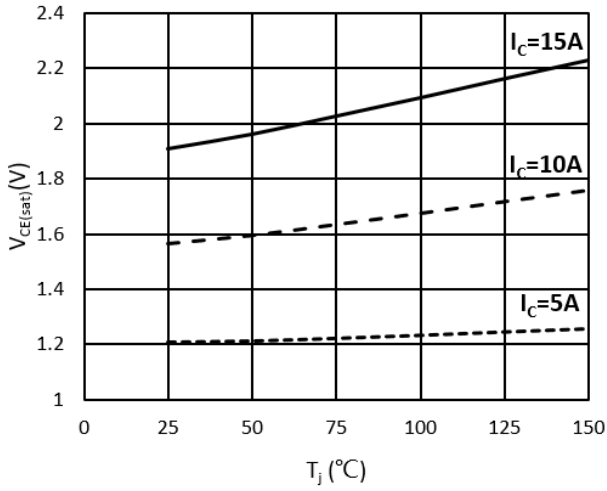


Figure 7.  $V_{CESAT}$  as a function of junction temperature ( $V_{GE}=15V$ )

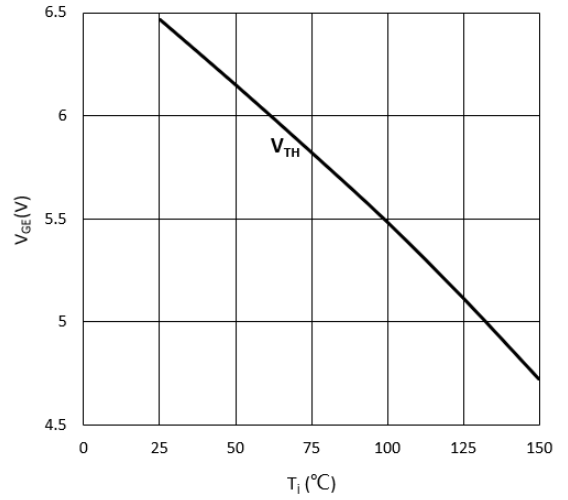


Figure 8.  $V_{TH}$  as a function of junction temperature ( $I_{CE}=250\mu A$ )

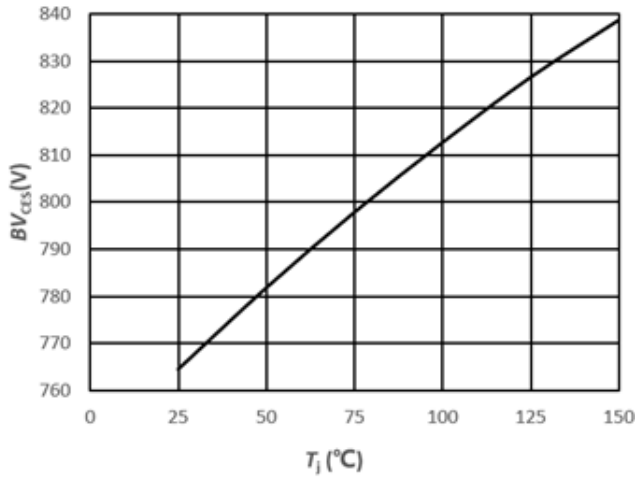


Figure 9. BV as a function of junction temperature ( $I_{CE}=250\mu A$ )

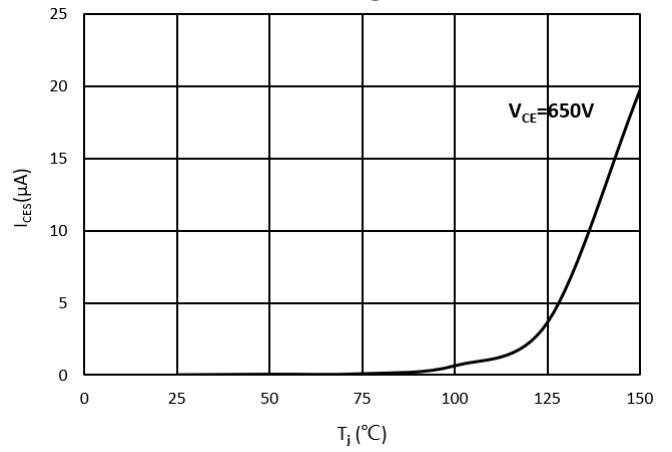


Figure 10.  $I_{CES}$  leakage current as a function of junction temperature

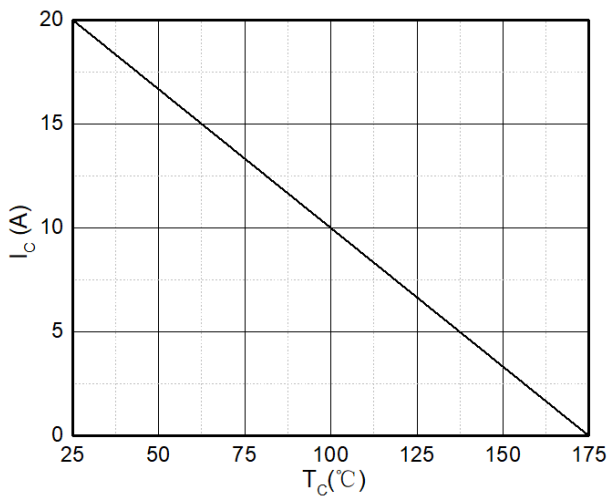


Figure 11. Collector current as a function of case temperature ( $V_{GE} \geq 15V, T_j \leq 175^\circ C$ )

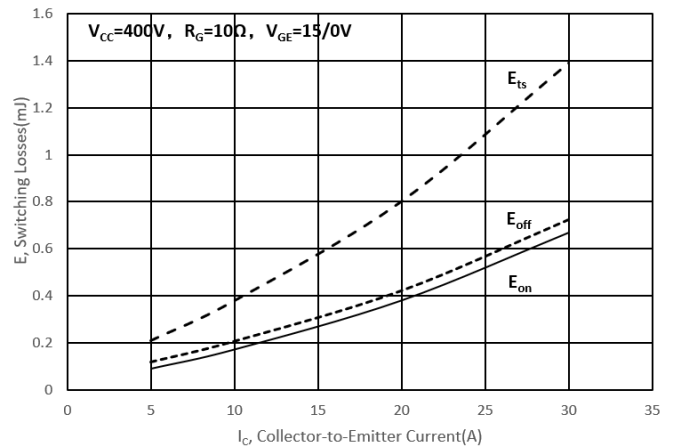


Figure 12.  $E_{on}, E_{off}$  as a function of  $I_C$  ( $T_j=25^\circ C$ )

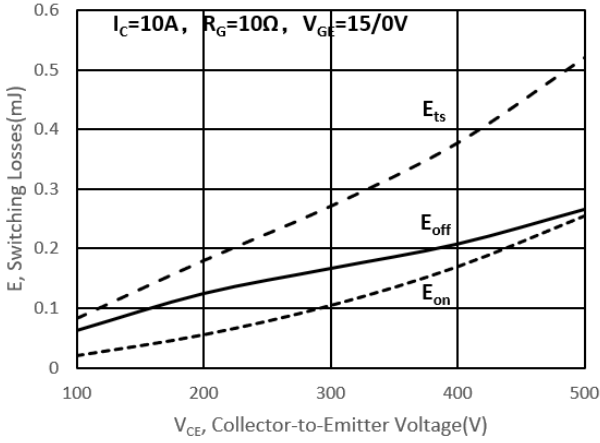


Figure 13.  $E_{on}$ ,  $E_{off}$  as a function of  $V_{CE}$  ( $T_j = 25^\circ C$ )

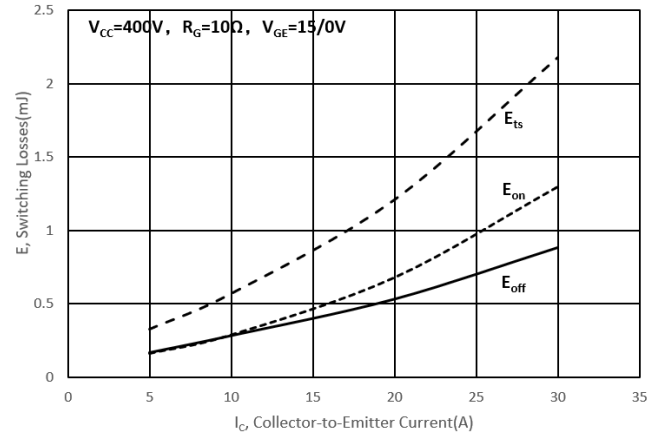


Figure 14.  $E_{on}$ ,  $E_{off}$  as a function of  $I_C$  ( $T_j = 150^\circ C$ )

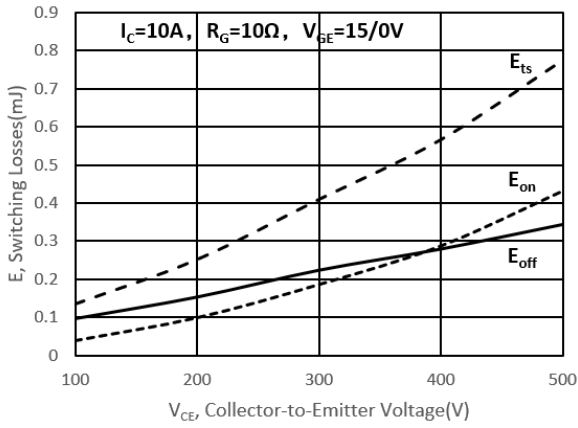


Figure 15.  $E_{on}$ ,  $E_{off}$  as a function of  $V_{CE}$  ( $T_j = 150^\circ C$ )

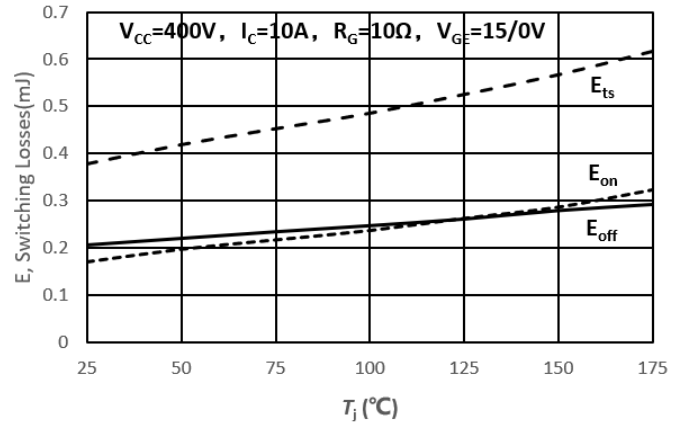
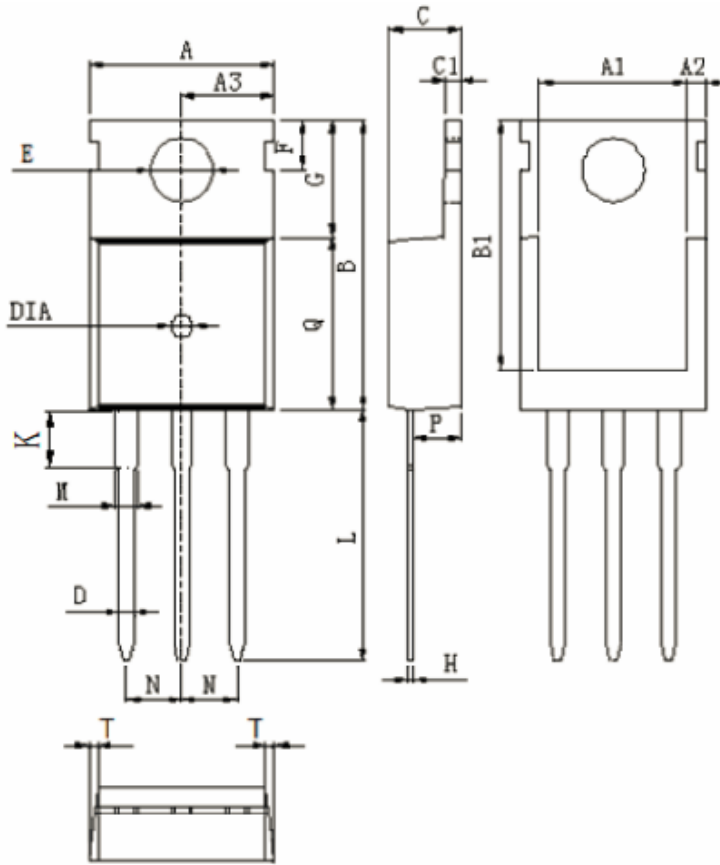


Figure 16.  $E_{on}$ ,  $E_{off}$  as a function of junction temperature

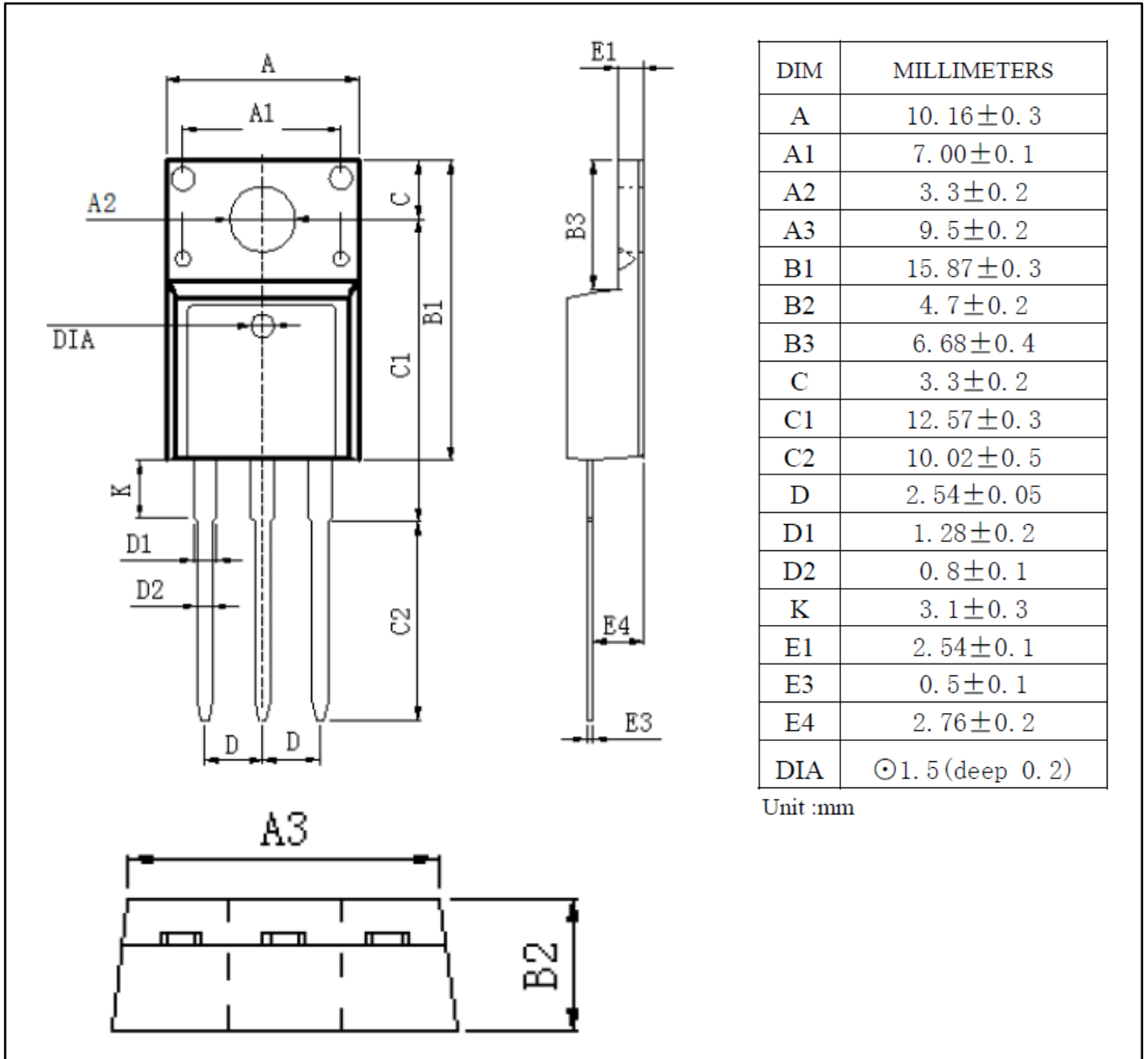
TO-220-3L



DIM	MILLIMETERS
A	10.0±0.3
A1	8.64±0.2
A2	1.15±0.1
A3	5.0±0.2
B	15.8±0.4
B1	13.2±0.3
C	4.56±0.1
C1	1.3±0.2
D	0.8±0.2
E	3.6±0.2
F	2.95±0.3
G	6.5±0.3
H	0.5±0.1
K	3.1±0.2
L	13.2±0.4
M	1.25±0.1
N	2.54±0.1
P	2.4±0.3
Q	9.0±0.3
T	W:0.35
DIA	⊙1.5 (deep 0.2)

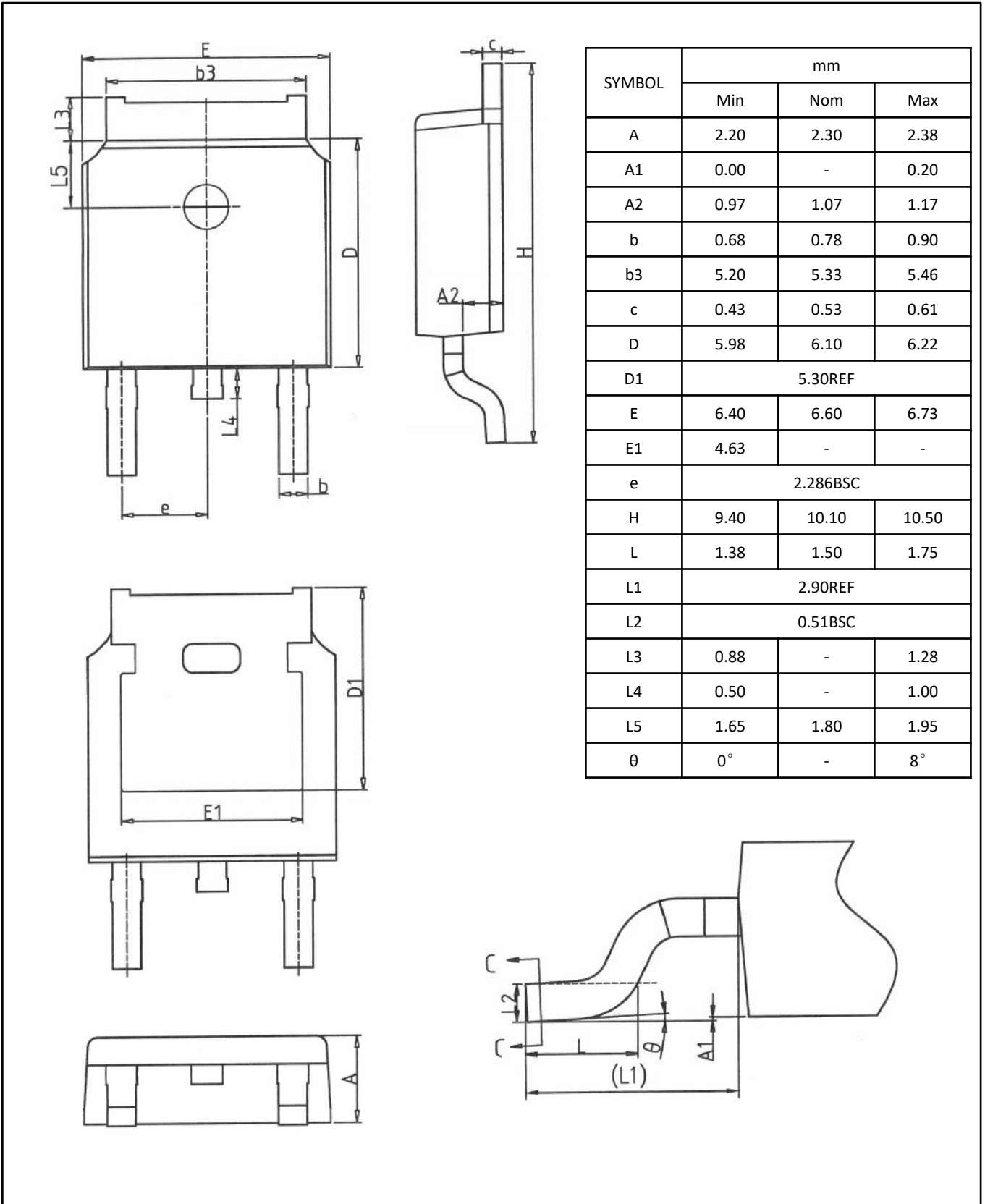
Unit :mm

TO-220F-3L





TO-252





**Revision History:**

Revision	Date	Subjects (major changes since last revision)
1.0	2021-12	Initial version
1.1	2023-03	Add the graphs



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